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Investigation on viscosity, surface tension and non-reactive wettability of melting Ag-Cu-Xwt.%Ti active filler metals

Jian Yang, Yue Wang, Jihua Huang, Wanli Wang, Zheng Ye, Shuhai Chen, Yue Zhao



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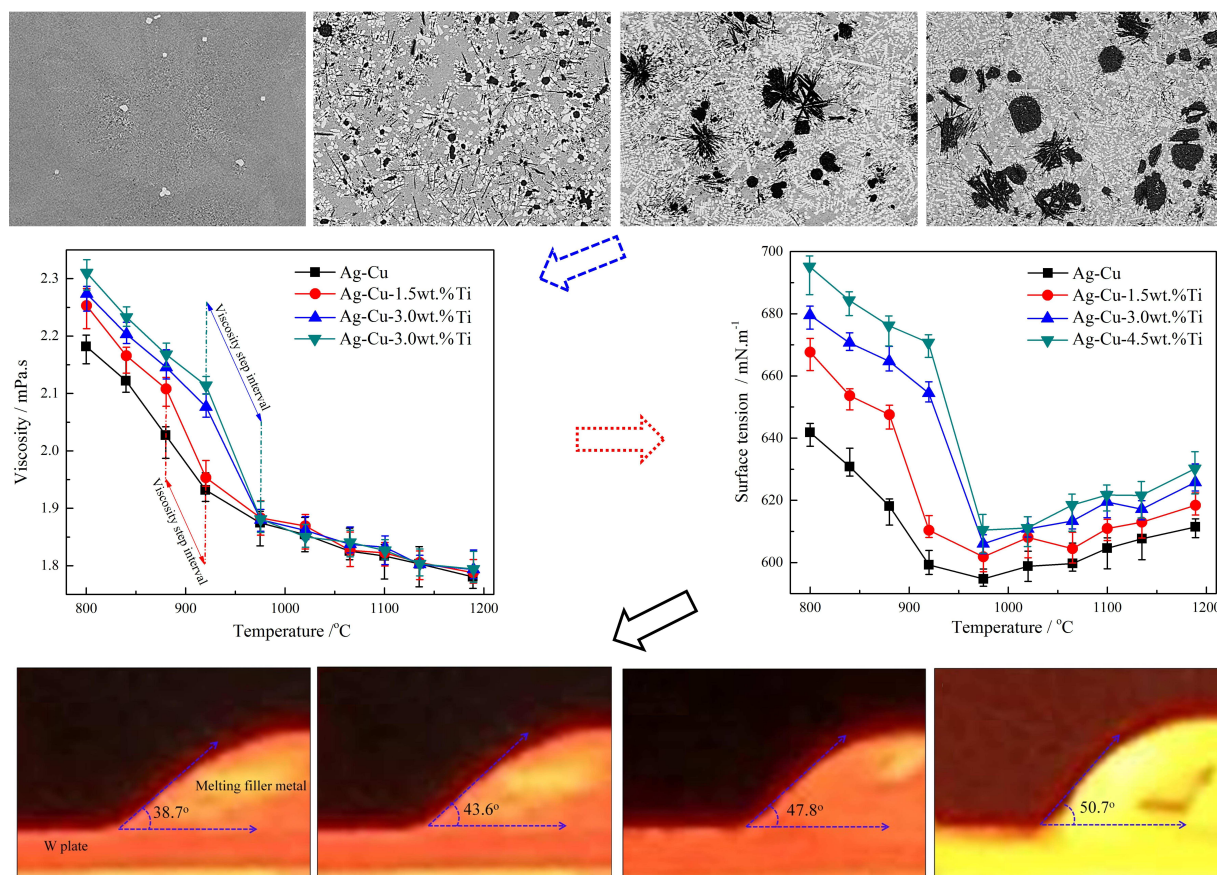
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